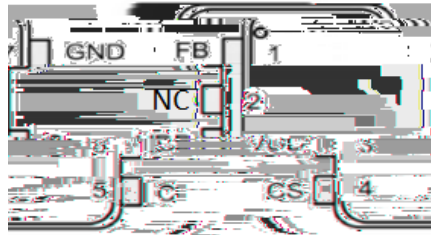
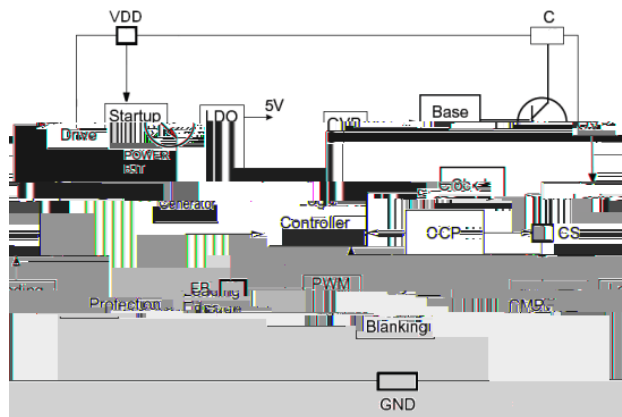


Rev.B May.-2019



1	FB	
2	NC	
3	VDD	
4	CS	
5 6	C	BJT
7	GND	



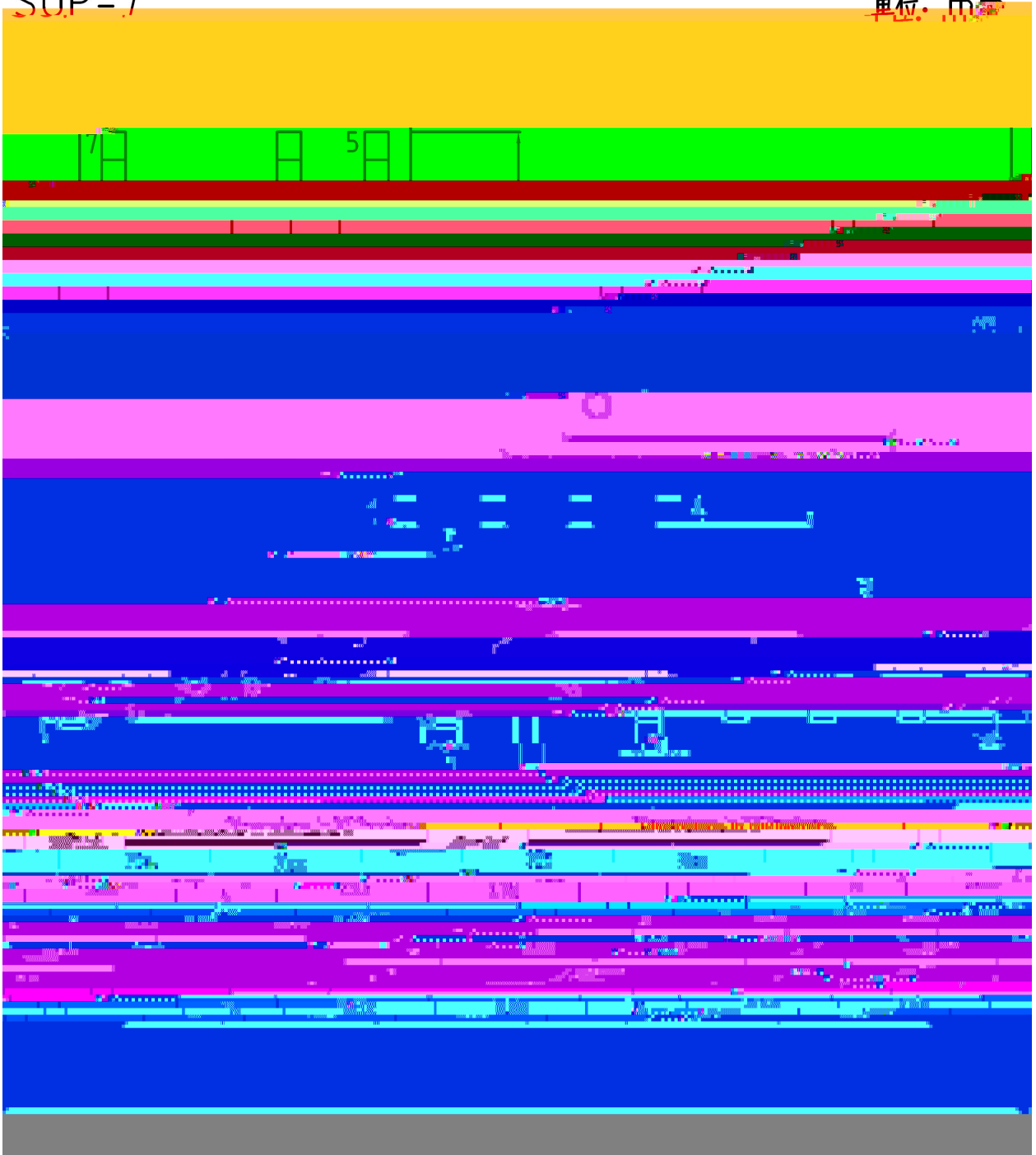
1

Note 1: If the device operating conditions over the maximum rating of the above-mentioned conditions, may cause permanent damage to the device. The above parameters is only part of the operating

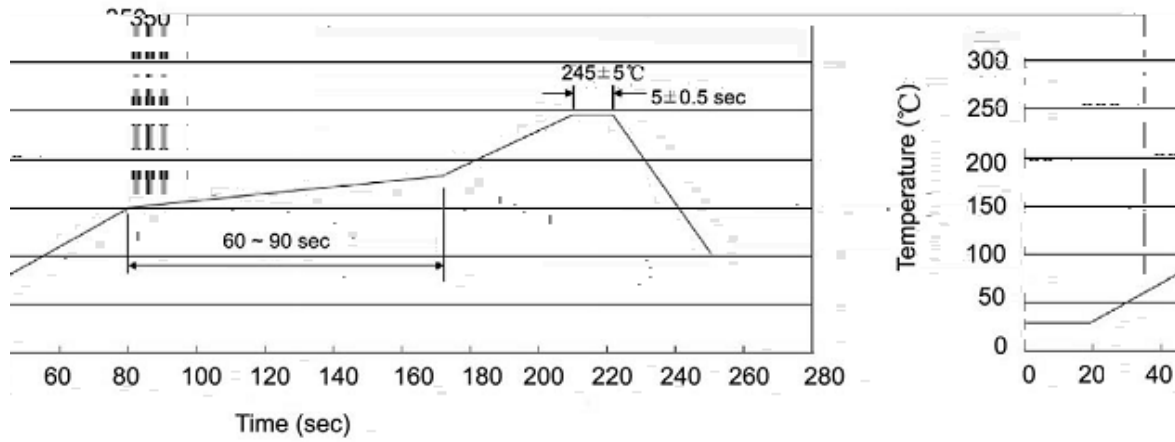
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Maximum Cable Drop Compensation (CDC) Current	$I_{\text{Cable_max}}$			45		uA
CS Input Leading Edge Blanking Time	T_{LEB}			350		ns
Minimum overcurrent protection threshold	$V_{\text{TH_OCPmin}}$			500		mV
Maximum overcurrent protection threshold	$V_{\text{TH_OCPmax}}$			550		mV

SOP-7

单位: mm



Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- | | | | |
|---|---------|-----------|---|
| 1 | 150 180 | 60 90sec; | 1.Preheating:150~180 , Time:60~90sec. |
| 2 | 245±5 | 5±0.5sec; | 2.Peak Temp.:245±5 , Duration:5±0.5sec. |
| 3 | 2 10 | /sec. | 3. Cooling Speed: 2~10 /sec. |

260±5

10±1 sec.

Temp.:260±5

Time:10±1 sec

/ REEL

Package Type